SV1020i

Ultimate 1U Server Unlocks Business Agility



3rd Gen Intel® Xeon® Scalable Processor

The Intel's first 10nm 3rd generation Intel® Xeon® scalable processors empower the system to support dynamic computational workloads, and accelerate business outcomes through significant breakthrough in core architecture, performance and security.

Application

Head Node Server

High Performance Computing

Hyperscale Data Center

Software-defined Storage

Enterprise Application Server

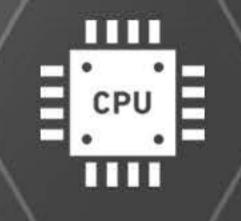
Virtualization

OCP 3.0 Add-on Card Support

The standard-compliant OCP 3.0 slot enables the installation of a high-speed NIC, which delivers high bandwidth and ultra-low latency in a cluster environment.

Flexible I/O Configurations

The server supports either 2 PCIe FHHL cards or 3 PCIe LP cards in a slim 1U form factor, providing great flexibility as well as maximum I/O density.



One/Two 3rd Gen. Intel® Xeon® Scalable Processor(s)



32 x DDR4 RDIMM/ LRDIMM



12 x 2.5" NVMe/SATA Drives



1+1 Redundancy, Platinum Level



1U Rackmount



SV1020i

Specifications

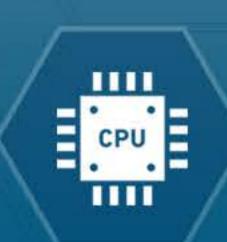


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Processor

One/Two 3rd Gen. Intel® Xeon® Scalable Processor(s)





Storage

Front

12 x 2.5" Hot-swap NVMe/SATA Drives
Support Intel VROC

Internal

2 x Gen3 NVMe M.2 (22110)

1 x USB3.0 (Type A)

1 x USB2.0 Header

1 x 7-P SATA Port

Front Panel

1 x Power Button with LED

1 x UID Button with LED

1 x Reset Button

1 x System Health LED

Rear Panel

2 x FHHL Cards or 3 x LP Cards

1 x RJ45 for BMC Dedicated Management

1 x VGA

2 x USB 3.0

1 x Power Status LED

1 x UID LED

1 x System Health LED

Security

1 x TPM 2.0 Module Lattice MachXO3D Root-of-Trust Engine



4 x PCle Gen4 x16 Slots
1 x OCP 3.0 NIC PCle Gen4 x16 Slot
2 x Internal LP-SlimSAS Connectors
(Gen4 x8)

Management

1 x ASPEED AST2500 BMC Support Intelligent Platform Management Interface v.2.0

PSUs

1+1 Redundant 1600W Platinum Power Supplies

Fans

8 x 40*56mm Dual Rotor System Fans

BSMI

Certification
UL/CB/CE/FCC/IC/



Chassis Dimensions
(H x W x D)

1.71" x 17.32" x 29.88" / 43.5mm x 440.0mm x 777.8mm

Form Factor

1U Rackmount

• Operating Temperature 0°C to 35°C (32°F to 95°F)

Non-operating Temperature -40°C to 70°C (-40°F to 158°F)

Operating Relative Humidity

8% to 85%RH

Non-operating Relative Humidity

5% to 95%RH



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